

HIGH EFFICIENCY FAST RECOVERY DIODE

MAIN PRODUCT CHARACTERISTICS

$I_{F(AV)}$	4 A
V_{RRM}	200 V
$V_F (max)$	0.85 V
$T_j (max)$	150 °C

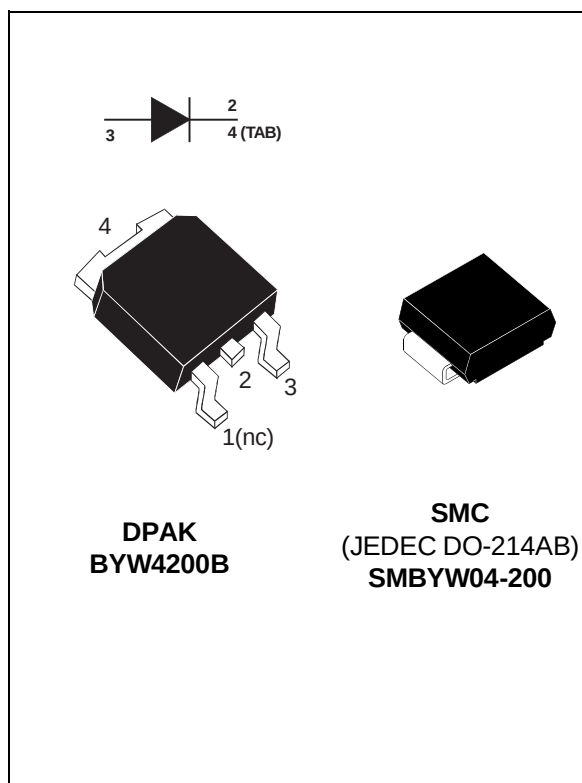
FEATURES AND BENEFITS

- SUITED TO SMPS AND DRIVES
- SURFACE MOUNT PACKAGE
- VERY LOW FORWARD LOSSES
- NEGLIGIBLE SWITCHING LOSSES
- HIGH SURGE CURRENT CAPABILITY

DESCRIPTION

Single chip rectifier suited to Switch Mode Power Supplies and high frequency converters.

Packaged in DPAK and SMC, this surface mount device is intended for use in low voltage, high frequency inverters, free wheeling and rectification applications.



ABSOLUTE RATINGS (limiting values)

Symbol	Parameter			Value	Unit
V_{RRM}	Repetitive peak reverse voltage			200	V
$I_{F(RMS)}$	RMS forward current			10	A
$I_{F(AV)}$	Average forward current $\delta = 0.5$	DPAK SMC	$T_{case} = 130^{\circ}C$ $T_{lead} = 70^{\circ}C$	4	A
I_{FSM}	Surge non repetitive forward current		$t_p = 10\text{ ms}$ sinusoidal	70	A
T_{stg}	Storage temperature range			- 65 to + 150	°C
T_j	Maximum operating junction temperature			150	°C

SMBYW04-200 / BYW4200B

THERMAL RESISTANCE

Symbol	Parameter	Package	Value	Unit
R _{th(j-c)}	Junction to case	DPAK	5	°C/W
R _{th(j-l)}	Junction to leads	SMC	20	°C/W

STATIC ELECTRICAL CHARACTERISTICS

Symbol	Tests Conditions	Tests Conditions	Min.	Typ.	Max.	Unit
I _R *	Reverse leakage current	T _j = 25°C	V _R = V _{RRM}		10	μA
		T _j = 100°C		0.15	0.5	mA
V _F **	Forward voltage drop	T _j = 25°C	I _F = 12 A		1.25	V
		T _j = 100°C	I _F = 4 A	0.8	0.85	

Pulse test : * tp = 5 ms, δ < 2 %
** tp = 380 μs, δ < 2%

To evaluate the maximum conduction losses use the following equation :
 $P = 0.7 \times I_{F(AV)} + 0.037 I_{F(RMS)}^2$

RECOVERY CHARACTERISTICS

Symbol	Test Conditions			Min.	Typ.	Max.	Unit
t _{rr}	T _j = 25°C	I _F = 1A V _F = 30V	dI _F /dt = -50 A/μs		26	35	ns
t _{fr}	T _j = 25°C	I _F = 4A V _{FR} = 1.1 x V _F max	dI _F /dt = -50 A/μs		20		ns
V _{FP}	T _j = 25°C	I _F = 4A	dI _F /dt = -50 A/μs		5		V

Fig. 1: Average forward power dissipation versus average forward current.

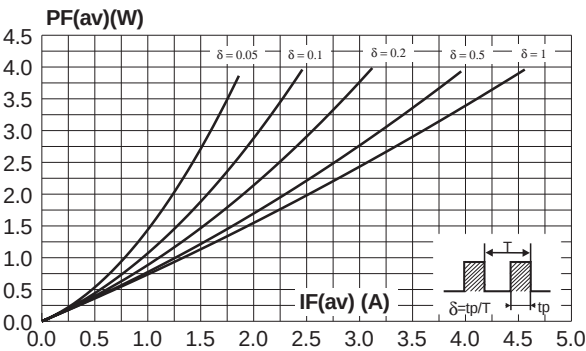
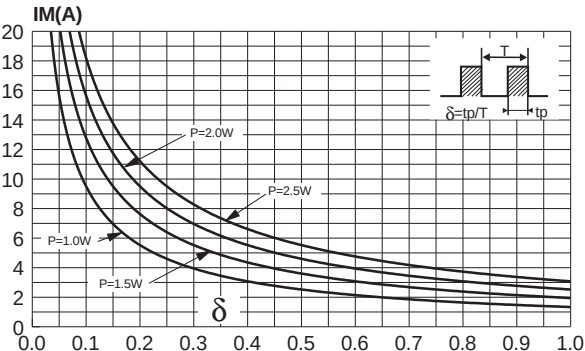


Fig. 2: Peak current versus form factor.



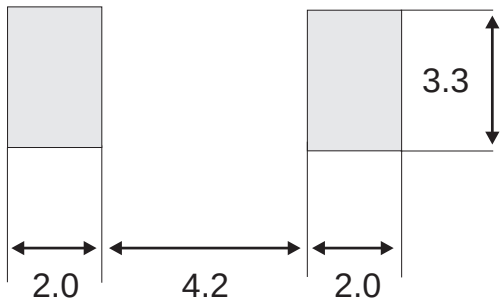
SMBYW04-200 / BYW4200B

PACKAGE MECHANICAL DATA
SMC

The image contains three mechanical drawings of a component. The top drawing is a top view showing a central rectangular area with two smaller rectangular areas on the left and right. Dimension E1 is the width of the central area, and D is the height of the central area. The bottom-left drawing is a front view showing a trapezoidal top with two side flaps. Dimension E is the width of the top, E2 is the width of the base, L is the length of the side flaps, and C is the height of the side flaps. The bottom-right drawing is a side view showing a trapezoidal top with a central rectangular area. Dimension A1 is the height of the top, A2 is the height of the central area, and b is the width of the central area.

REF.	DIMENSIONS			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A1	1.90	2.45	0.075	0.096
A2	0.05	0.20	0.002	0.008
b	2.90	3.2	0.114	0.126
c	0.15	0.41	0.006	0.016
E	7.75	8.15	0.305	0.321
E1	6.60	7.15	0.260	0.281
E2	4.40	4.70	0.173	0.185
D	5.55	6.25	0.218	0.246
L	0.75	1.60	0.030	0.063

FOOT PRINT (in millimeters)



Ordering code	Marking	Package	Weight	Base qty	Delivery mode
SMBYW04-200	D20	SMC	0.243g	2500	Tape and reel
BYW4200B	W4200	DPAK	0.30g	75	Tube
BYW4200B-RL	W4200	DPAK	0.30g	2500	Tape and reel

- Epoxy meets UL 94,V0
- Band indicates cathode